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| Substitute for Form 1449 A & B/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i> | | | | Complete if Known | |
| | | Application Number | Based on PCT/JP2004/017317 | | |
| | | Confirmation Number | Unknown 549355 | | |
| | | Filing Date | May 15, 2006 | | |
| | | First Named Inventor | Yuji ITOH | | |
| | | Art Unit | Unknown 1796 | | |
| | | Examiner Name | Unknown M. Reza Asdjodi | | |
| | | Attorney Docket Number | Q94902 | | |
| Sheet | 1 | of | 1 | | |

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| Examiner Signature | M. Reza Asdjodi | Date Considered | 12/05/2007 |
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